### International Conference on Advances in Materials Science, Communication and **Microelectronics (ICAMCM-2021)** February 19-20, 2021 (Virtual Mode) Conference **Organised by**

**Department of Electronics and Communication Engineering** 

(NBA Accredited)

website

Jaipur Engineering College and Research Centre, Jaipur, Rajasthan, India

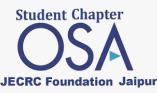


AND RESEARCH CENTRE











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# **Registration Details**

Registration Categories	Early Bird		Regular	
	Materials Today	IOP: MSE	Materials Today	IOP: MSE
Student and Research Scholar	3000 (INR)	5000 (INR)	4000 (INR)	6000 (INR)
Academi cians	4000 (INR)	6000 (INR)	5000 (INR)	7000 (INR)
Industry Delegate	5000 (INR)	7000 (INR)	6000 (INR)	8000 (INR)
Foreign Delegate	75 (USD)	100 (USD)	100 (USD)	125 (USD)
#Extra Paper (Indian Author)	2000 (INR)	4500 (INR)	2500 (INR)	5000 (INR)
#Extra Paper (Foreign Author)	65 (USD)	90 (USD)	90 (USD)	100 (USD)

# The extra paper registration fees are for those authors who register for more than one paper. After registration of first paper, ich extra paper will be discounted according to extra paper charges. To avail the discount on extra papers, the registrations of all papers should be made through same author.

# Important Date

Last Date of Full Paper Submission	31 December 2020			
Notification of Acceptance	10 January 2021			
Registration Deadline (early bird)	25 January 2021			

## **Publication and indexing:**

**Publication Partner** 

All the accepted papers related to Material Science track will be published in the Materials Today: Proceedings, Indexed in Scopus (Elsevier) and the CPCI (Thomson Reuters, Web of Science). The accepted papers of the remaining tracks will be published in IOP Conference Series: Materials Science and Engineering (MSE) indexed in Scopus and open access.

## **ICAMCM-2021**

The International Conference on Advances in Materials Science, Communication and Microelectronics (ICAMCM-2021) is to be organized with the perception to address the various issues of the society in the fields of material science, communication engineering and electronic technology. In this conference, it will be expected that researchers will bring new prospects for collaboration across intra and inter disciplines to facilitated novel concepts.

## **JECRC** Foundation

A journey of Two decades for JECRC, having more than 4000 students on campus under 6 UG programs, has earned laurels to their students, faculty members and for the institute in many ways. More than 10000 alumni's spread over the globe has climbed the ladder to leadership positions and providing mentorship to their juniors by way of skill development, incubation, startup, research and angel funding. Contribution towards International publications, technical activities, co-curricular activities by faculty members, students and delivery of Outcome based education is recognized by National Board of Accreditation and AICTE. JECRC has become synonymous to placements and JECRCians have made their presence felt at every reputed company / government organization.

### **Department of Electronics and Communication Engineering (NBA Accredited)**

The Electronics and Communication Engineering (ECE) Department has a rich tradition in research and teaching. The ECE department is NBA accredited. The research interests of the faculty members of the department encompass the wide area of applied and fundamental aspects of Electronics and Communication Engineering. Collaboration between the research groups of the department and with other departments is also a practice.

### **Call for papers**

The technical committee invites authors to submit papers which clearly present the work, methods, originality, significance and applications from the following topics of interest, but are not limited to.

- Material Science, VLSI, MEMS and nanotechnology 1.
- 2. Digital signal, Image and video processing
- RF, wireless and Optical Fiber Communication 3.
- 4. Real time-based embedded systems

#### **Submission of the papers:**

- For Materials Today: Proceedings: Authors should prepare the manuscript according to the a) template given at https://www.materialstoday.com/proceedings-template. The manuscript can be submitted at: http://ees.elsevier.com/MATPR/default.asp
- For IOP: Materials Science and Engineering: Authors should prepare the manuscript according to b) the guidelines given at: https://publishingsupport.iopscience.iop.org/author-guidelines-forconference-proceedings/ The manuscript can be submitted at: https://easychair.org/conferences/?conf=icamcm2021



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